

# 85V 6.5mohm N-channel SGT MOSFET

## AKG85N065P

### Description:

This N channel SGT MOSFET has been designed to low on-state resistance, low switching loss with good  $E_{AS}$  performance, especially for DC-DC and Motor driving applications.

### Features:

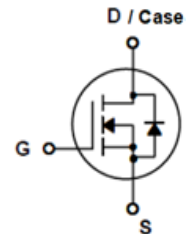
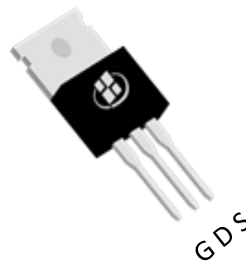
- Low  $R_{DS(ON)}$
- RoHS compliant <sup>(Note 1)</sup>
- Halogen-free <sup>(Note 1)</sup>

### Applications:

- Battery Management System
- Motor Drivers
- DC-DC Converter

### Key Performance Parameters:

Parameter	Value	Unit
$V_{DS}$	85	V
$R_{DS(ON), max} @ V_{GS} = 10V$	6.5	m $\Omega$
$I_D$	120	A



### Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKG85N065P	TO-220	G85N065P	Tube	1000 per box

### Notes:

1. Contact ALKAIDSEMI sales for detail information

## Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-Source Voltage	85	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ ) <sup>(Note 1)</sup>	150	A
	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ ) <sup>(Note 2)</sup>	120	A
	Drain Current - Continuous ( $T_C = 100^\circ\text{C}$ )	95	A
$I_{DM}$	Drain Current - Pulsed <sup>(Note 3)</sup>	440	A
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(Note 4)</sup>	225	mJ
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	250	W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

## Thermal Characteristics

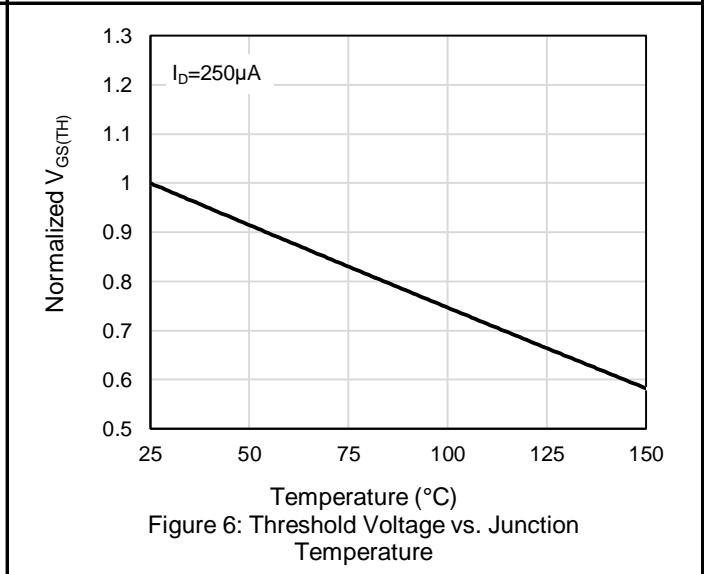
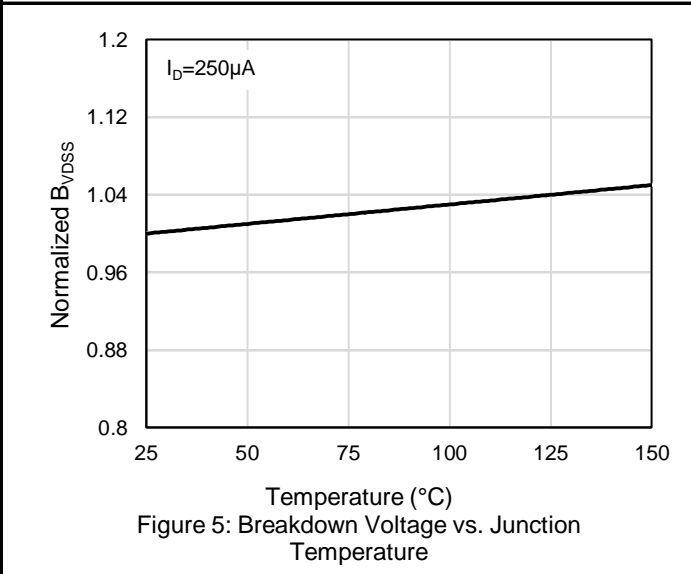
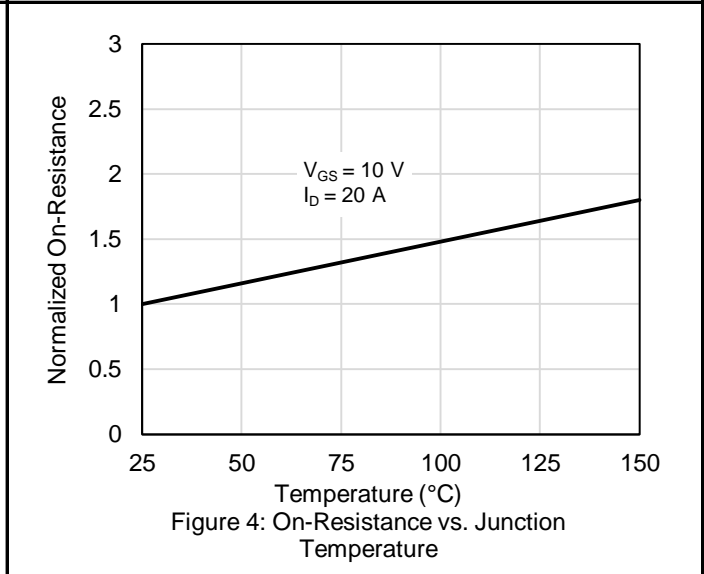
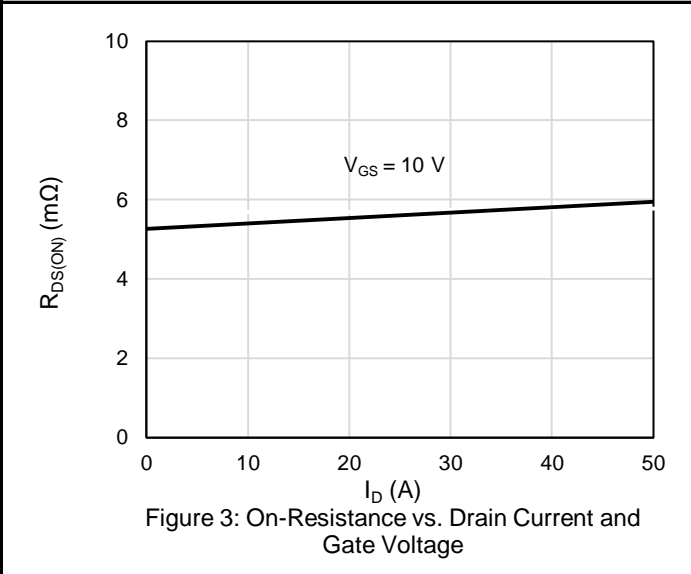
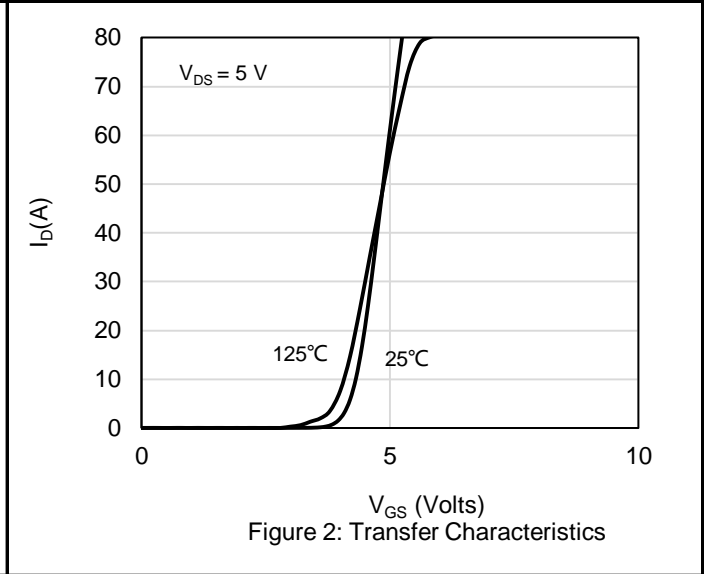
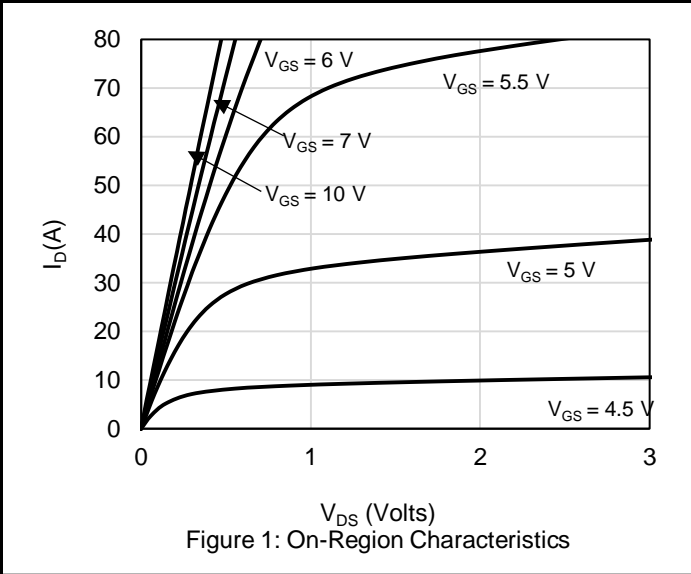
Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady-State	0.5	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State <sup>(Note 5)</sup>	50	$^\circ\text{C}/\text{W}$

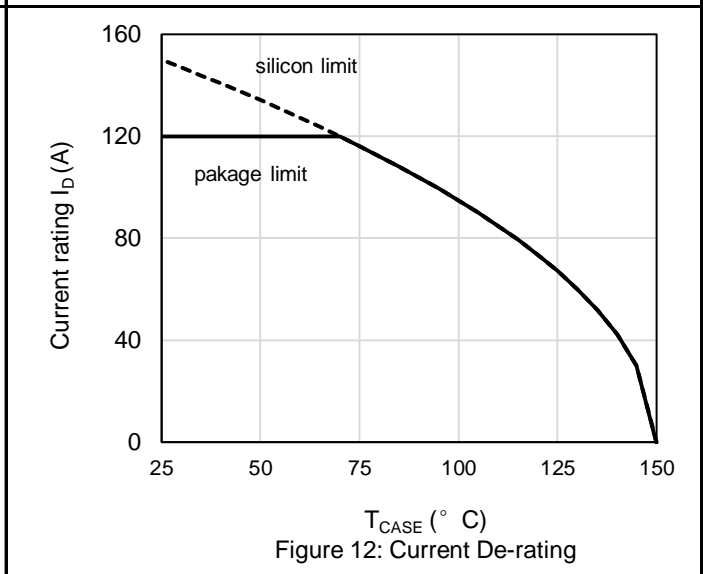
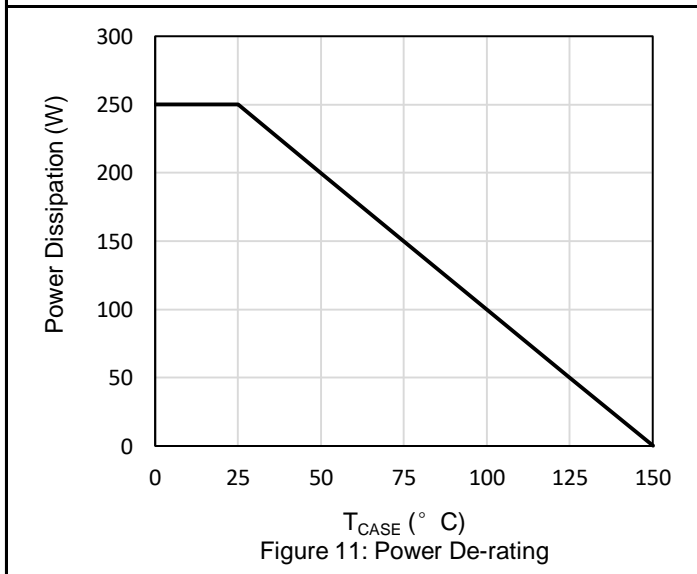
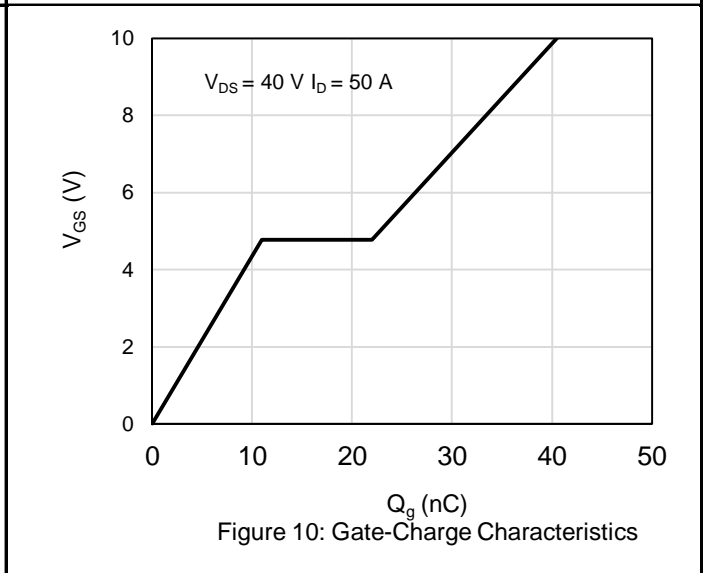
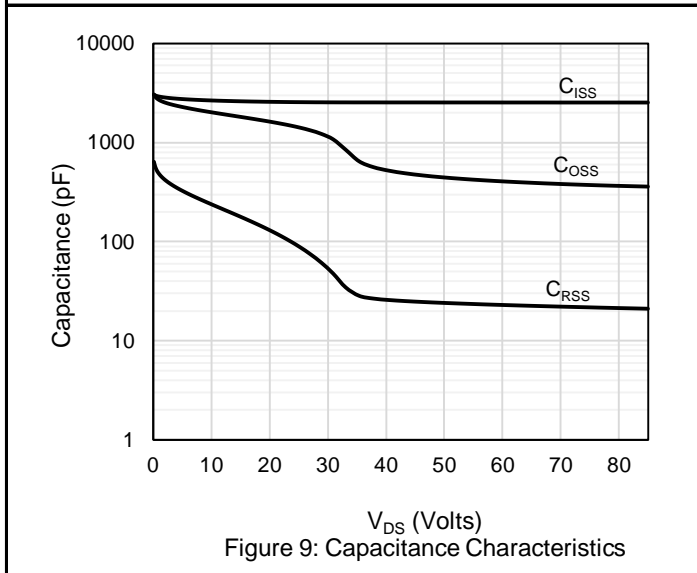
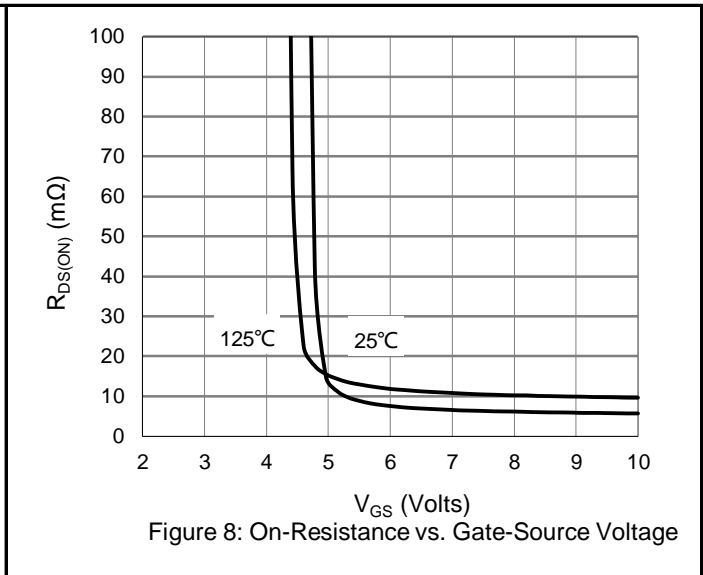
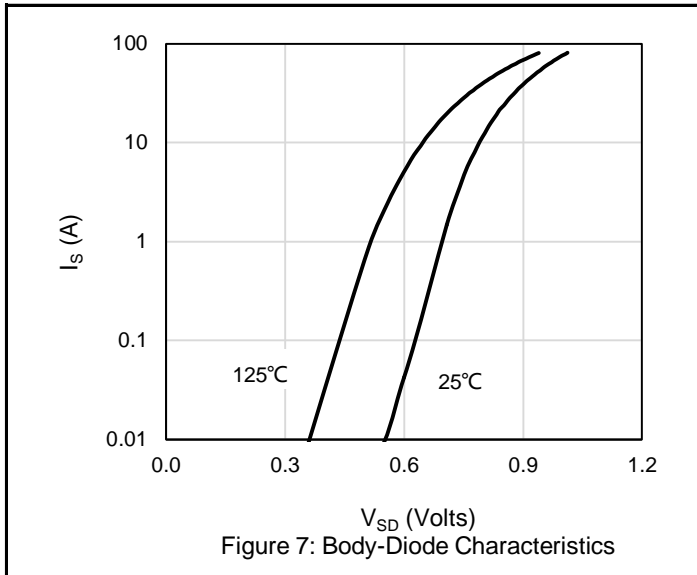
### Notes:

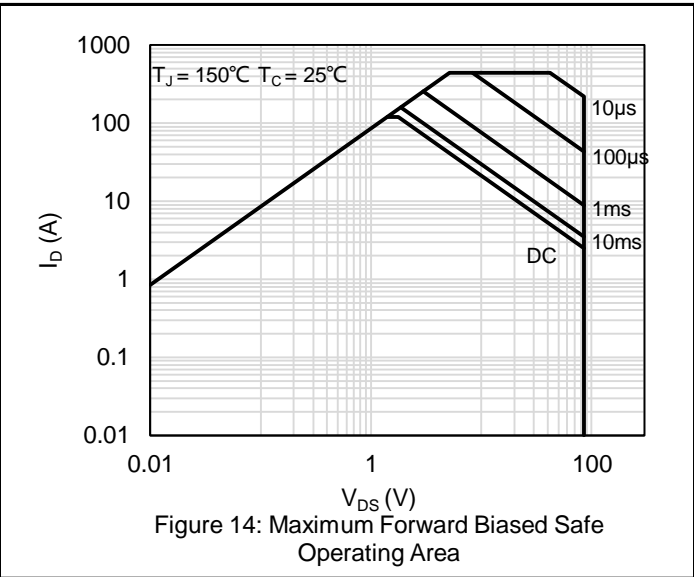
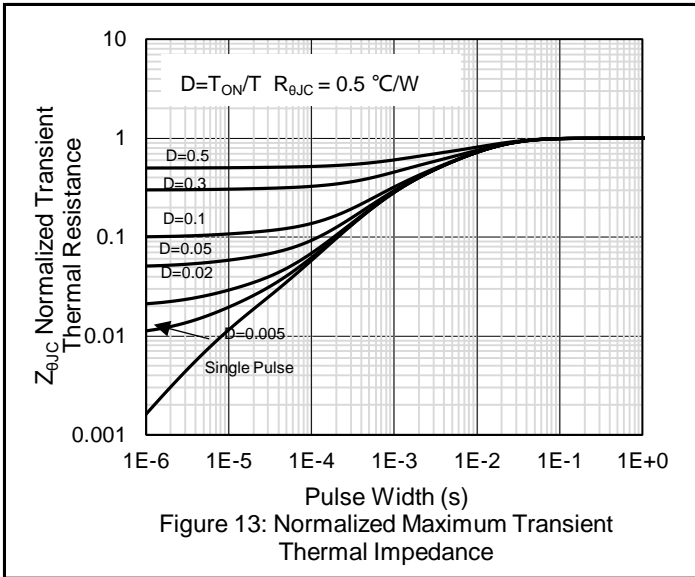
1. The max drain current rating is silicon limited
2. The max drain current rating is package limited
3. Repetitive Rating: Pulse width limited by maximum junction temperature
4.  $L = 0.5 \text{ mH}$ ,  $V_{DD} = 48 \text{ V}$ ,  $I_{AS} = 30 \text{ A}$ ,  $R_G = 50 \Omega$ , Starting  $T_J = 25^\circ\text{C}$
5. Mount on minimum PCB layout

<b>Electrical Characteristics</b> ( $T_J = 25^\circ\text{C}$ unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	85			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 85\text{ V}, V_{GS} = 0\text{ V},$			1	$\mu\text{A}$
$I_{GSS}$	Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$			$\pm 100$	nA
$V_{GS(TH)}$	Gate Threshold voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2	3	4	V
$R_{DS(ON)}$	Drain-Source on-state resistance	$V_{GS} = 10\text{ V}, I_D = 50\text{ A}$		5.7	6.5	m $\Omega$
<b>Dynamic Characteristics</b>						
$C_{ISS}$	Input Capacitance	$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V},$ $F = 1\text{ MHz}$		2541		pF
$C_{OSS}$	Output Capacitance			520		pF
$C_{RSS}$	Reverse Transfer Capacitance			25.5		pF
$R_G$	Gate Resistance	$F = 1\text{ MHz}$		1.4		$\Omega$
<b>Switching Characteristics</b>						
$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 40\text{ V}, R_L = 0.8\ \Omega,$ $V_{GS} = 10\text{ V}, R_G = 3\ \Omega$		15		nS
$T_R$	Rise Time			33		nS
$T_{D(OFF)}$	Turn Off Delay Time			31		nS
$T_F$	Fall Time			12		nS
$Q_G$	Total Gate Charge	$V_{DD} = 40\text{ V}, I_D = 50\text{ A},$ $V_{GS} = 10\text{ V}$		40.5		nC
$Q_{GS}$	Gate-Source Charge			11		nC
$Q_{GD}$	Gate-Drain Charge			11		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Body-Diode Forward Current				120	A
$I_{SM}$	Maximum Pulsed Body-Diode Forward Current <sup>(NOTE 1)</sup>				440	A
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 50\text{ A}$		0.93		V
$T_{RR}$	Reverse recovery time	$V_{DD} = 40\text{ V}, I_D = 20\text{ A},$ $di/dt = 100\text{ A}/\mu\text{S}$		59		ns
$Q_{RR}$	Reverse recovery charge			51.5		nC
$I_{RRM}$	Peak Reverse Recovery Current			1.4		A

# Electrical Characteristics Diagrams

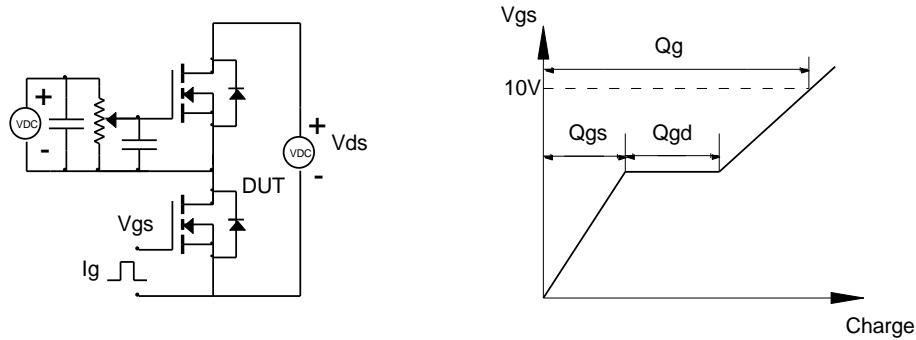




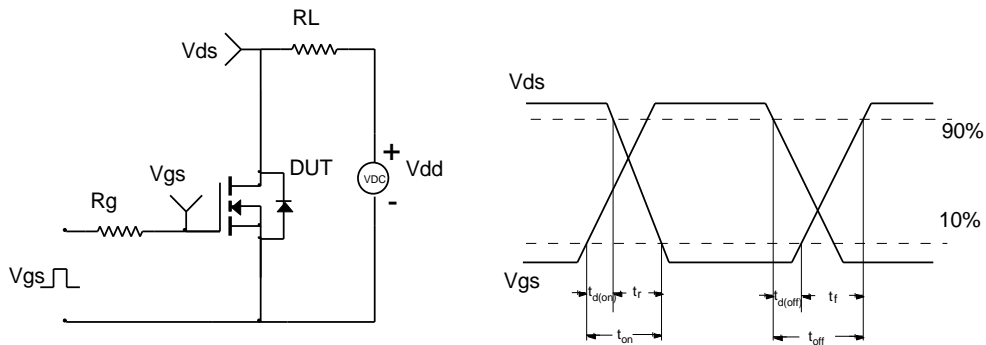


# Test Circuit and Waveform

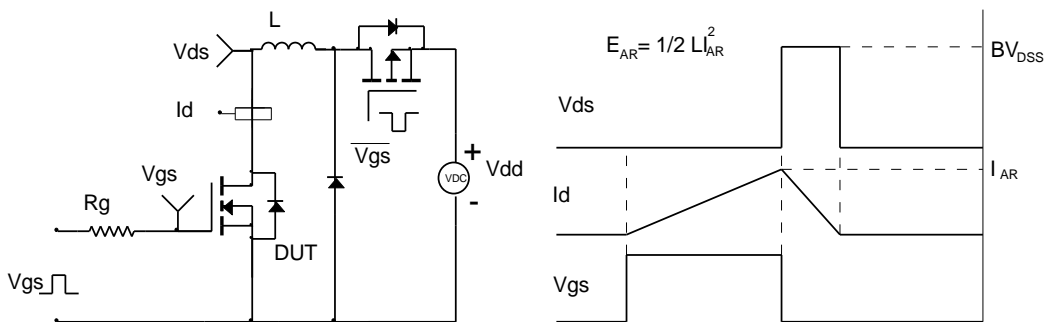
Gate Charge Test Circuit & Waveform



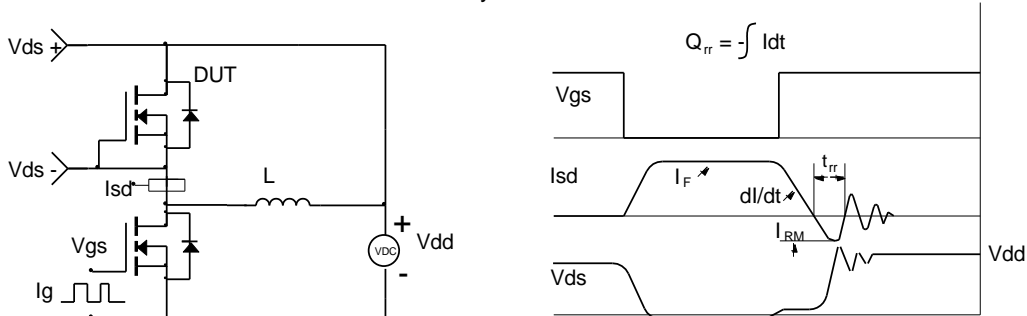
Resistive Switching Test Circuit & Waveforms



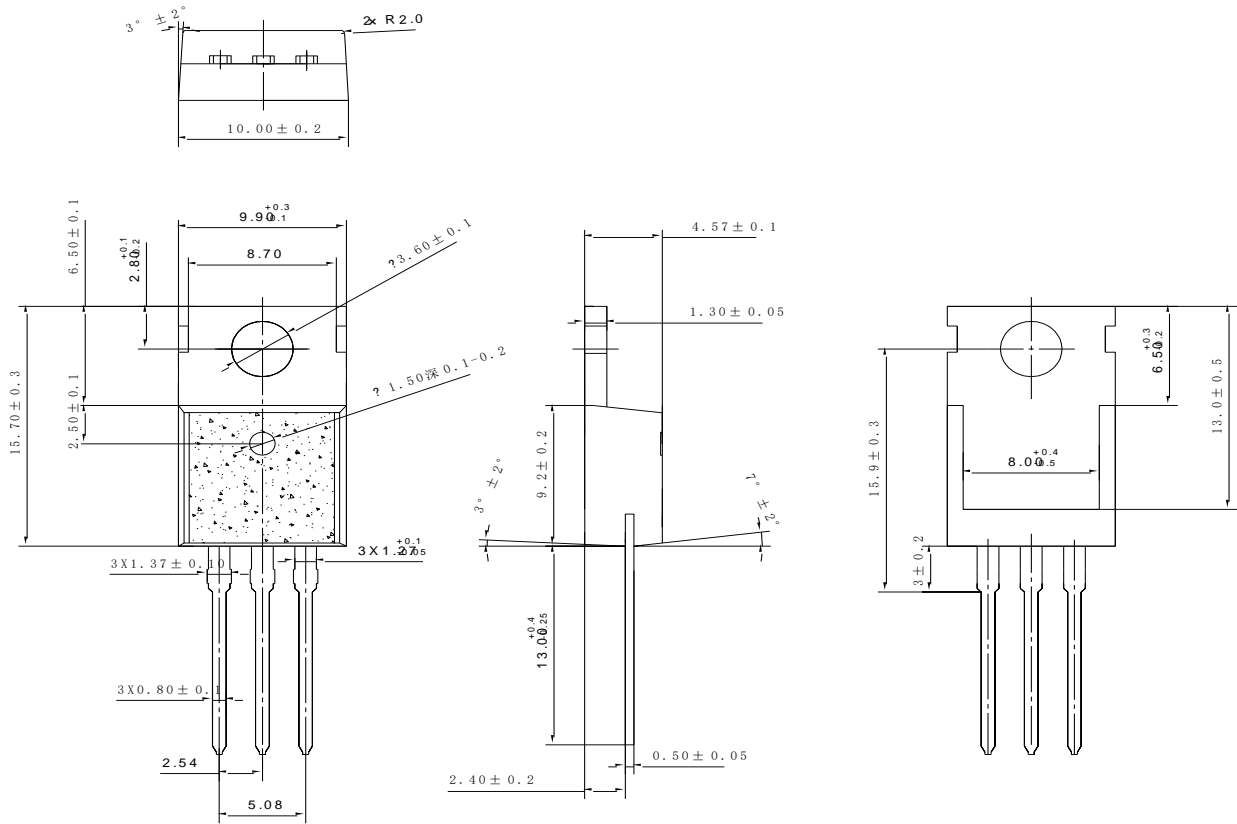
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



# Package Outlines





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## Marking Information



G85N065P  
XXXXXXXX

Note:

G85N065P = Product Name Code

XXXXXXXX = Date code

Contact ALKAIDSEMI sales for detail information

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## Revision History

Revision	Release Date	Remark
Rev.1.1	2023/7/22	

## Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

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